**NICHIA CORPORATION** 

**SPECIFICATIONS FOR WARM WHITE LED** 

# **NWSL229AT**

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
- RoHS Compliant



## **SPECIFICATIONS**

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	${ m I}_{\sf F}$	2000	mA
Pulse Forward Current	${ m I}_{\sf FP}$	2400	mA
Allowable Reverse Current	$I_{R}$	85	mA
Power Dissipation	$P_{D}$	6.6	W
Operating Temperature	$T_{opr}$	-40~100	°C
Storage Temperature	$T_{stg}$	-40~100	°C
Junction Temperature	T <sub>1</sub>	150	°C

<sup>\*</sup> Absolute Maximum Ratings at  $T_S=25$ °C.

(2) Initial Electrical/Optical Characteristics

It	em	Symbol	Condition	Тур	Max	Unit
Forward Voltage	Forward Voltage			3.0	-	V
	Luminous Flux	Ф	I <sub>F</sub> =1400mA	631	-	lm
R70	Luminous Intensity	$I_{v}$	I <sub>F</sub> =1400mA	162	-	cd
	Color Rendering Index	Ra	I <sub>F</sub> =1400mA	73	-	ı
	Luminous Flux	Ф	I <sub>F</sub> =1400mA	574	-	lm
R8000	Luminous Intensity	$I_{v}$	I <sub>F</sub> =1400mA	150	-	cd
	Color Rendering Index	Ra	I <sub>F</sub> =1400mA	83	-	ı
	x	-	I <sub>F</sub> =1400mA	0.3818	-	-
Chromaticity Coordinate	у	-	I <sub>F</sub> =1400mA	0.3797	-	ı
Thermal Resistance	Thermal Resistance			2.3	3.3	°C/W

<sup>\*</sup> Characteristics at  $T_S=25$ °C.

<sup>\*</sup>  $I_{\text{FP}}$  conditions with pulse width  $\leq 10 \text{ms}$  and duty cycle  $\leq 10 \%$ .

<sup>\*</sup> Luminous Flux value as per CIE 127:2007 standard.

<sup>\*</sup> Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

<sup>\*</sup>  $R_{\theta JS}$  is the thermal resistance from the junction to the  $T_S$  measurement point.

#### RANKS

Item	Rar	nk	Min	Max	Unit		
	M1		3.1	3.3			
Forward Voltage	L2		2.9	3.1	V		
	L1		2.7	2.9			
	M600		600	650			
	M550		550	600	lm		
Luminous Flux	M500		500	550			
	M450		450	500			
	R70	Ra	70	-	-		
Color Rendering Index		R <sub>a</sub>	80	-	ı		
	R8000	R <sub>9</sub>	0	=	=		

### Color Ranks

The color rank has a chromaticity range within a 3-step MacAdam ellipse.

			Rank	Rank	Rank
		sm273	sm303	sm353	sm403
	х	0.4578	0.4338	0.4073	0.3818
Center Point	у	0.4101	0.4030	0.3917	0.3797
Minor Axis	а	0.004056	0.004107	0.004098	0.004071
Major Axis	b	0.007872	0.008391	0.008796	0.009282
Ellipse Rotation Angle	Φ	-36.05	-36.00	-35.47	-35.95

The color rank has a chromaticity range within a 5-step MacAdam ellipse.

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm2750a	sm2750b	sm2750c	sm2750d	sm2750e	sm2750f			
	х		0.4578							
Center Point	у	0.4101								
Minor Axis	а			0.00	6760					
Major Axis	b	0.013120								
Ellipse Rotation Angle	Ф		-36.05							

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm3050a	sm3050b	sm3050c	sm3050d	sm3050e	sm3050f			
	Х		0.4338							
Center Point	у		0.4030							
Minor Axis	а			0.00	6845					
Major Axis	b	0.013985								
Ellipse Rotation Angle	Ф		-36.00							

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm3550a	sm3550b	sm3550c	sm3550d	sm3550e	sm3550f			
	Х	0.4073								
Center Point	у	0.3917								
Minor Axis	а			0.00	6830					
Major Axis	b	0.014660								
Ellipse Rotation Angle	Ф			-35	.47					

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm4050a	sm4050b	sm4050c	sm4050d	sm4050e	sm4050f			
	Х		0.3818							
Center Point	у	0.3797								
Minor Axis	а			0.00	6785					
Major Axis	b	0.015470								
Ellipse Rotation Angle	Ф		-35.95							

The color rank has a chromaticity range within a 7-step MacAdam ellipse.

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm2770a	sm2770b	sm2770c	sm2770d	sm2770e	sm2770f			
Courtou Point	х		0.4578							
Center Point	у		0.4101							
Minor Axis	а			0.00	9464					
Major Axis	b	0.018368								
Ellipse Rotation Angle	Ф		-36.05							

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm3070a	sm3070b	sm3070c	sm3070d	sm3070e	sm3070f			
Camban Daint	х	0.4338								
Center Point	У		0.4030							
Minor Axis	a			0.00	9583					
Major Axis	b	0.019579								
Ellipse Rotation Angle	Φ		-36.00							

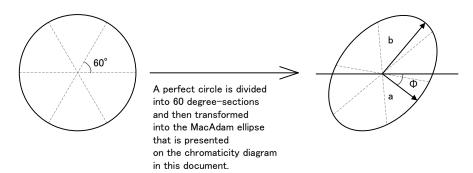
		Rank	Rank	Rank	Rank	Rank	Rank			
		sm3570a	sm3570b	sm3570c	sm3570d	sm3570e	sm3570f			
	Х		0.4073							
Center Point	У	0.3917								
Minor Axis	а			0.00	9562					
Major Axis	b	0.020524								
Ellipse Rotation Angle	Φ		-35.47							

		Rank	Rank	Rank	Rank	Rank	Rank			
		sm4070a	sm4070b	sm4070c	sm4070d	sm4070e	sm4070f			
Center Point	х		0.3818							
	у		0.3797							
Minor Axis	а			0.00	9499					
Major Axis	b	0.021658								
Ellipse Rotation Angle	Ф		-35.95							

- \* Ranking at  $T_S=25$ °C.
- \* Forward Voltage Tolerance: ±0.05V
- \* Luminous Flux Tolerance: ±7%
- \* Color Rendering Index R<sub>a</sub> Tolerance: ±2
- \* Color Rendering Index  $R_9$  Tolerance:  $\pm 6.5$
- \* The  $R_9$  value for the above rank shall be greater than 0.
- \* Chromaticity Coordinate Tolerance: ±0.005
- \* LEDs from the above ranks will be shipped.

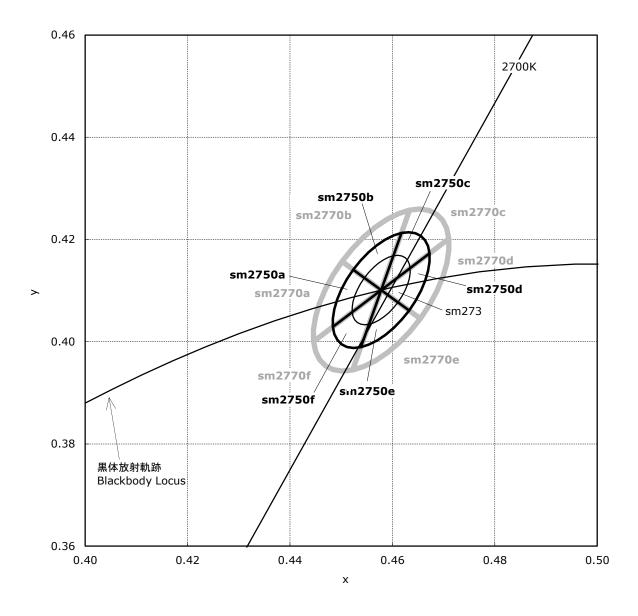
The rank combination ratio per shipment will be decided by Nichia.

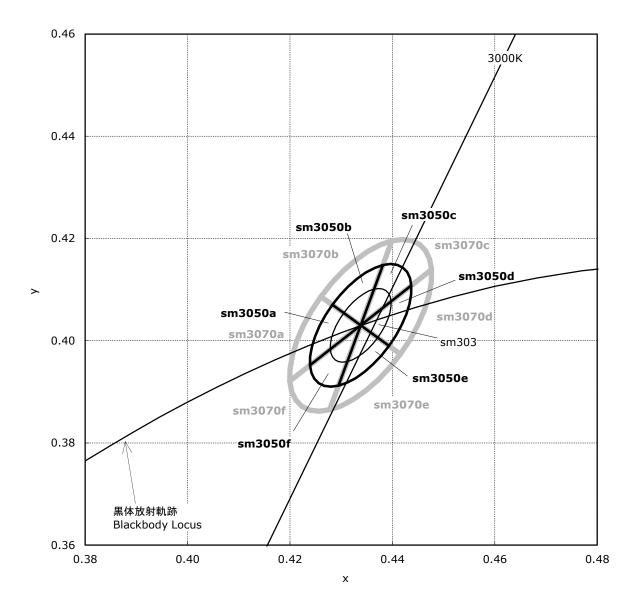
Definition of the MacAdam ellipse ranks:

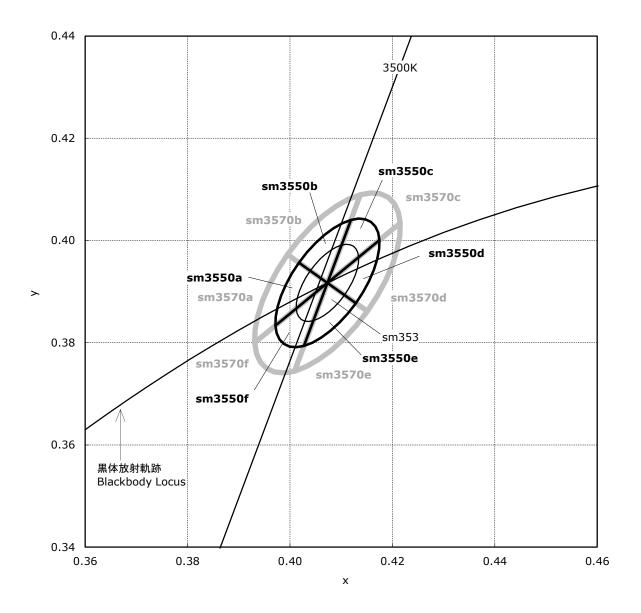


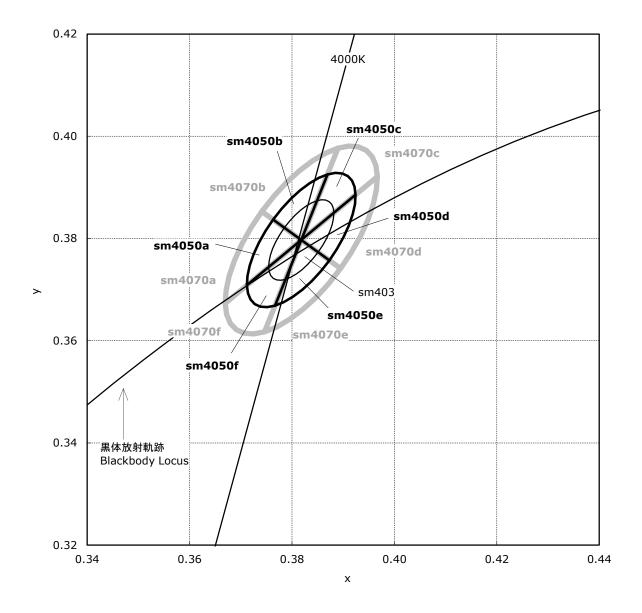
Luminous Flux Ranks by Color Rank, Color Rendering Index Rank

Luminous Flux Ranks by Color Rank, Color Rendering Index Rank						
	Ranking by					
	Luminous Flux					
Ranking by		M450	M500	M550	M600	
Color Coordinates,						
Color Rendering Index						
sm273,sm2750a,sm2750b,sm2750c,sm2750d,sm2750e,sm2750f,						
sm2770a,sm2770b,sm2770c,sm2770d,sm2770e,sm2770f	R8000					
sm303,sm3050a,sm3050b,sm3050c,sm3050d,sm3050e,sm3050f,	R70					
sm3070a,sm3070b,sm3070c,sm3070d,sm3070e,sm3070f						
	R8000					
sm353,sm3550a,sm3550b,sm3550c,sm3550d,sm3550e,sm3550f,	sm3550d.sm3550e.sm3550f.					
sm3570a,sm3570b,sm3570c,sm3570d,sm3570e,sm3570f	R8000					
sm403,sm4050a,sm4050b,sm4050c,sm4050d,sm4050e,sm4050f,						
sm4070a,sm4070b,sm4070c,sm4070d,sm4070e,sm4070f	R70,R8000					





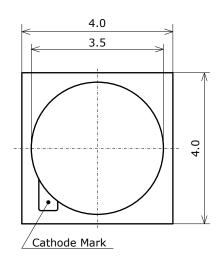


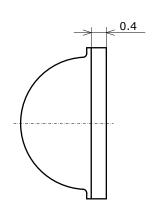


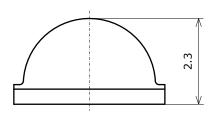
# **OUTLINE DIMENSIONS**

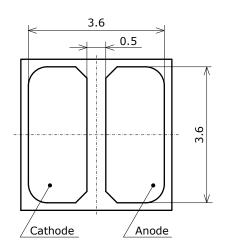
\* 本製品はRoHS指令に適合しております。 This product complies with RoHS Directive. NWSx229A 管理番号 No. STS-DA7-8594B

(単位 Unit: mm, 公差 Tolerance: ±0.2)

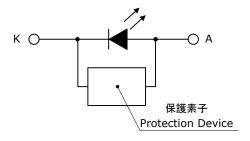






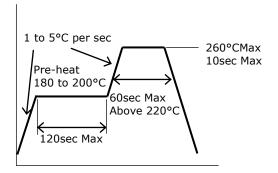


項目 Item	内容 Description	
パッケージ材質	セラミックス	
Package Materials	Ceramics	
プリコート材質 Pre-coating Materials	シリコーン樹脂 (蛍光体入り) Silicone Resin (with phosphor)	
レンズ材質	シリコーン樹脂	
Lens Materials	Silicone Resin	
電極材質	金メッキ	
Electrodes Materials	Au-plated	
質量 Weight	0.045g (TYP)	

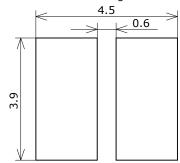


### **SOLDERING**

- Recommended Reflow Soldering Condition(Lead-free Solder)
- Recommended Hand Soldering Condition
   Temperature 350°C Max
   Soldering Time 3sec Max



• Recommended Soldering Pad Pattern



(単位 Unit: mm)

- \* This LED is designed to be reflow soldered on to a PCB. If dip soldered, Nichia cannot guarantee its reliability.
- \* Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.
- \* Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- \* Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- \* This product uses silicone resin for the lens and internal pre-coating resin; the silicone resin is soft.

If pressure is applied to the lens, it may cause the lens to be damaged, chipped, and/or delaminated. If the lens is damaged, chipped and/or delaminated, then the internal connections may be damaged and the reliability may decrease.

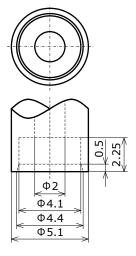
Ensure that pressure is not applied to the lens.

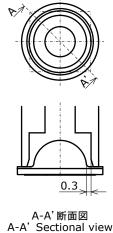
If an automatic pick and place machine is used for the LEDs, use a pick up nozzle that does not affect the lens. Recommended conditions:

Using a nozzle specifically designed for the LEDs is recommended (See the nozzle drawing below).

\* Ensure that the nozzle does not come in contact with the lens when it picks up an LED.

If this occurs, it may cause internal disconnection causing the LED not to illuminate.



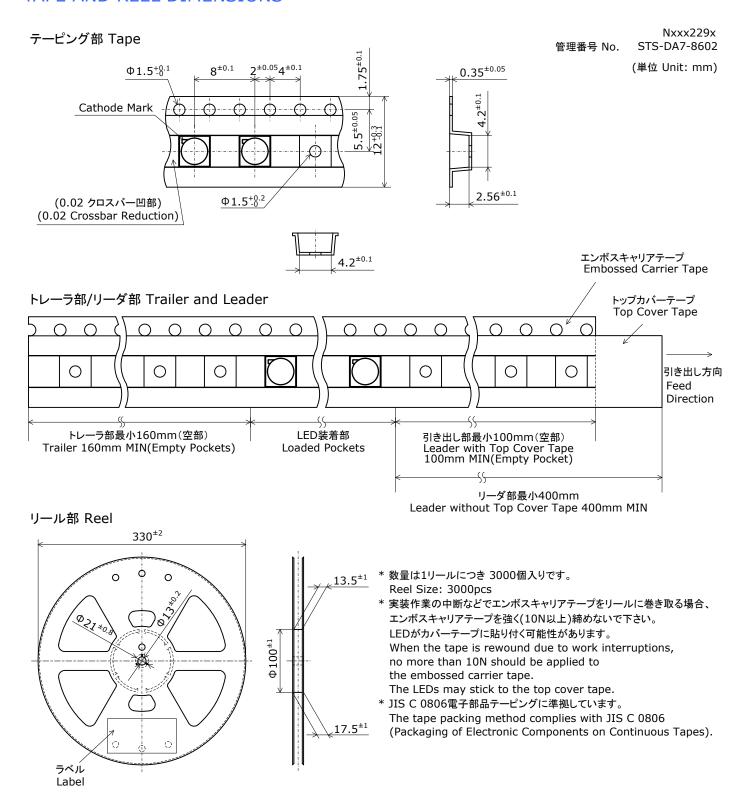


(単位 Unit: mm)

- \* Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used.
  - It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- \* When soldering, do not apply stress to the LED while the LED is hot.
- \* The recommended soldering pad pattern is designed for attachment of the LED without problems.

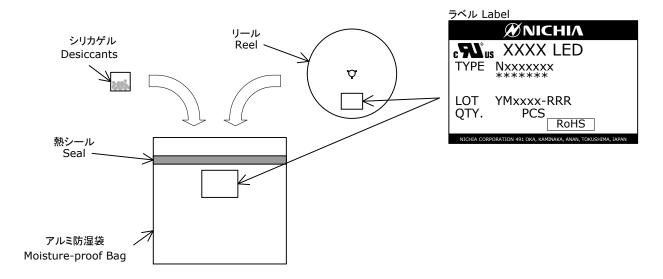
  When precise mounting accuracy is required, such as high-density mounting, ensure that the size and shape of the pad are suitable for the circuit design.
- \* Consider factors such as the reflow soldering temperature, hand soldering temperature, etc. when choosing the solder.
- \* When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- \* Make sure that there are no issues with the type and amount of solder that is being used.
- \* All of the electrode pads are on the backside of this product; solder connections will not be able to be seen nor confirmed by a normal visual inspection. When using the product, ensure that there are no issues with the soldering conditions.

### TAPE AND REEL DIMENSIONS

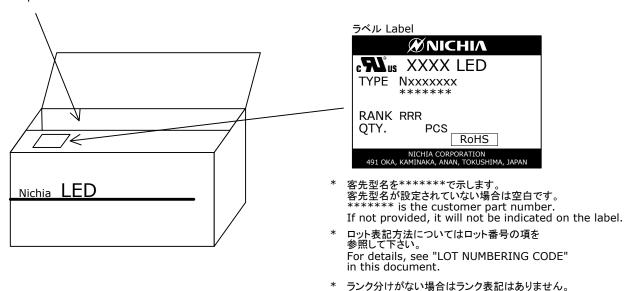


### PACKAGING - TAPE & REEL

シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。 Reels are shipped with desiccants in heat-sealed moisture-proof bags. Nxxxxxxx 管理番号 No. STS-DA7-4989



アルミ防湿袋を並べて入れ、ダンボールで仕切ります。 Moisture-proof bags are packed in cardboard boxes with corrugated partitions.



The label does not have the RANK field for

un-ranked products.

- \* 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
  Products shipped on tape and reel are packed in a moisture-proof bag.
  They are shipped in cardboard boxes to protect them from external forces during transportation.
- \* 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or expose the box to external forces as it may damage the products.
- \* ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water. The box is not water-resistant.
- \* 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
  Using the original package material or equivalent in transit is recommended.

## **LOT NUMBERING CODE**

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2016	G
2017	Н
2018	I
2019	J
2020	K
2021	L

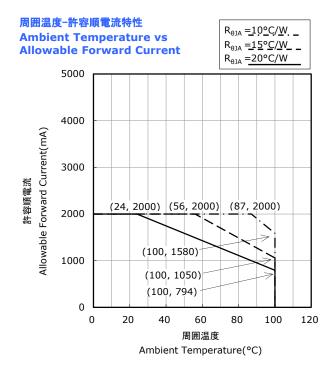
#### M - Month

Month	М	Month	М
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	А
5	5	11	В
6	6	12	С

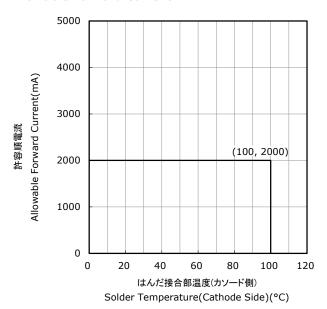
xxxx-Nichia's Product Number

RRR-Ranking by Color Coordinates, Ranking by Luminous Flux, Ranking by Forward Voltage, Ranking by Color Rendering Index

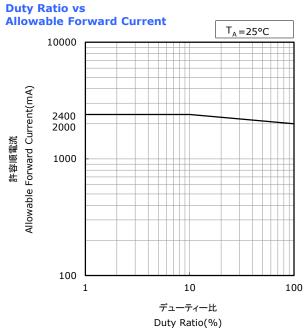
NWSx229A 管理番号 No. STS-DA7-8595



はんだ接合部温度(カソード側)-許容順電流特性 Solder Temperature(Cathode Side) vs Allowable Forward Current

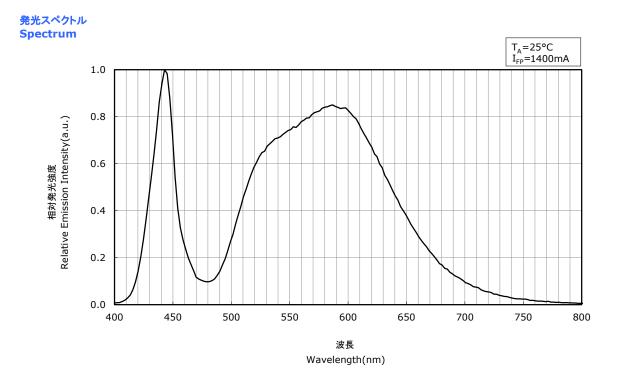


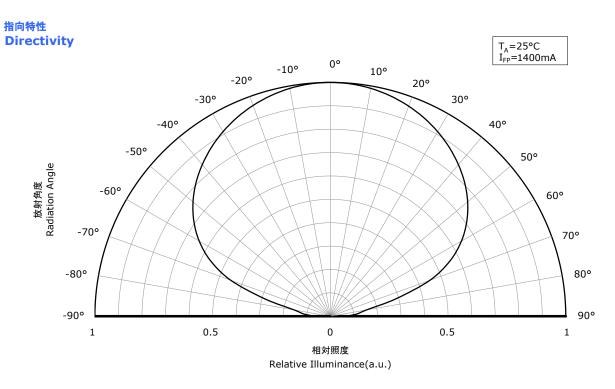
デューティー比-許容順電流特性



# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NWSL229A 管理番号 No. STS-DA7-8599

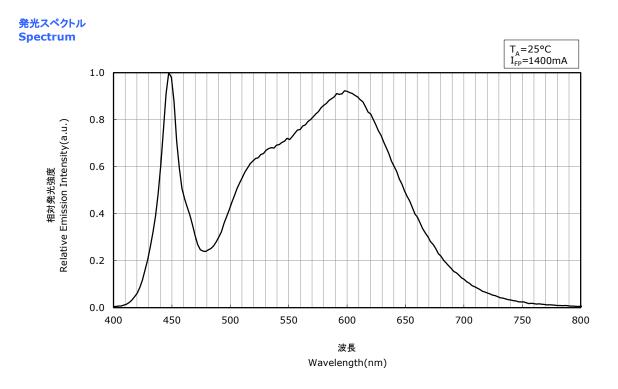


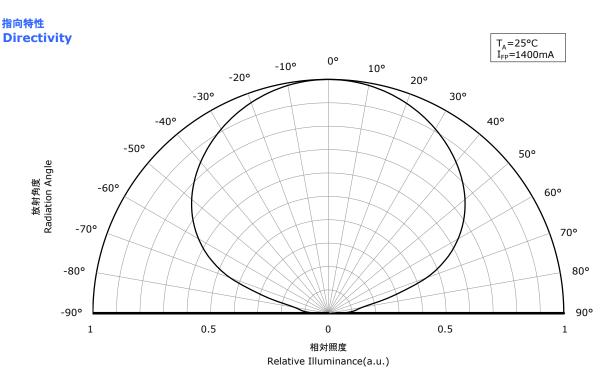


\* 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NWSL229A 管理番号 No. STS-DA7-10568

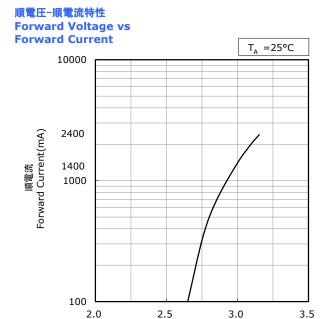




\* 本特性は演色性ランクR8000に対応しています。
The graphs above show the characteristics for R8000 LEDs of this product.

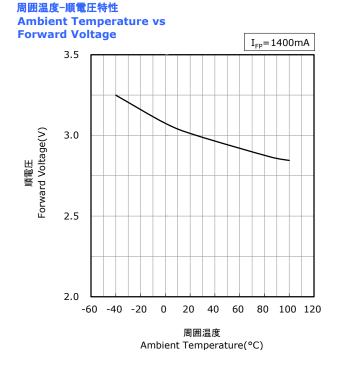
\* 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.

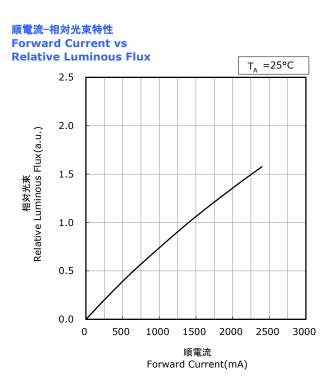
NWSL229A 管理番号 No. STS-DA7-8600A

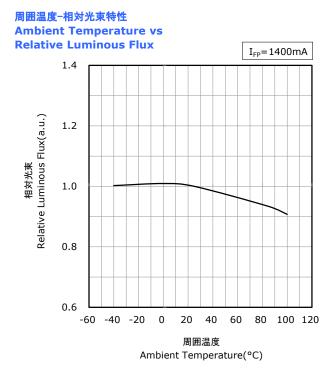


順電圧

Forward Voltage(V)



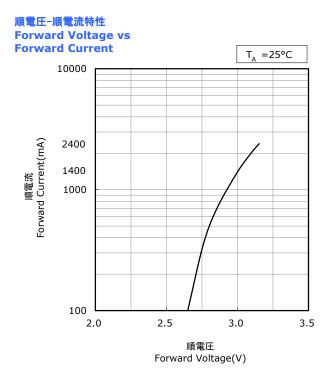


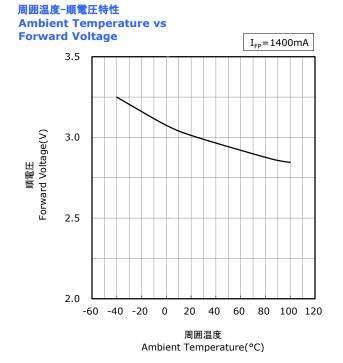


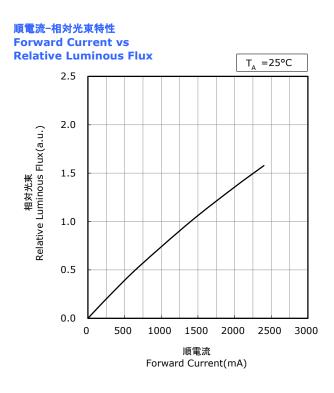
\* 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

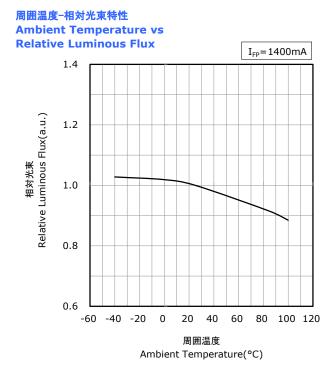
\* 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.

NWSL229A 管理番号 No. STS-DA7-10569





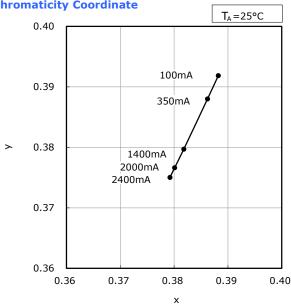




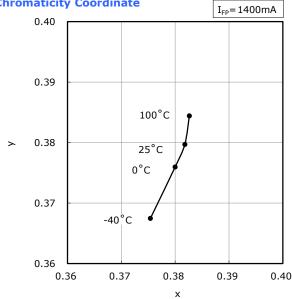
\* 本特性は演色性ランクR8000に対応しています。 The graphs above show the characteristics for R8000 LEDs of this product.

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NWSL229A 管理番号 No. STS-DA7-8601

順電流-色度 特性 Forward Current vs Chromaticity Coordinate

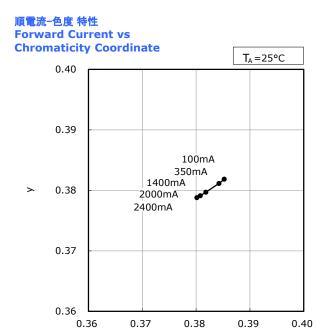




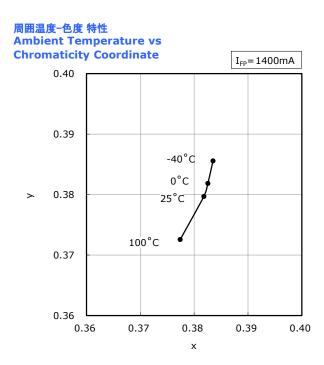


\* 本特性は演色性ランクR70に対応しています。 The graphs above show the characteristics for R70 LEDs of this product.

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NWSL229A 管理番号 No. STS-DA7-10570



Х



\* 本特性は演色性ランクR8000に対応しています。 The graphs above show the characteristics for R8000 LEDs of this product.

## **RELIABILITY**

### (1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	T <sub>sld</sub> =260°C, 10sec, 2reflows, Precondition: 30°C, 70%RH, 168hr		#1	0/22
Solderability (Reflow Soldering)	JEITA ED-4701 303 303A	T <sub>sld</sub> =245±5°C, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)		#2	0/22
Temperature Cycle	JEITA ED-4701 100 105	-40°C(30min)~25°C(5min)~ 100°C(30min)~25°C(5min)	100cycles	#1	0/22
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	25°C~65°C~-10°C, 90%RH, 24hr per cycle	10cycles	#1	0/22
High Temperature Storage	JEITA ED-4701 200 201	T <sub>A</sub> =100°C	1000hours	#1	0/22
Temperature Humidity Storage	JEITA ED-4701 100 103	T <sub>A</sub> =60°C, RH=90%	1000hours	#1	0/22
Low Temperature Storage	JEITA ED-4701 200 202	T <sub>A</sub> =-40°C	1000hours	#1	0/22
Room Temperature Operating Life		T <sub>A</sub> =25°C, I <sub>F</sub> =1600mA Test board: See NOTES below	1000hours	#1	0/22
High Temperature Operating Life		$T_A$ =100°C, $I_F$ =500mA Test board: See NOTES below	1000hours	#1	0/22
Temperature Humidity Operating Life		$60$ °C, RH=90%, $I_F$ =1000mA Test board: See NOTES below	l 500hours		0/22
Low Temperature Operating Life		$T_A$ =-40°C, $I_F$ =1400mA Test board: See NOTES below	1000hours	#1	0/22
Vibration	JEITA ED-4701 400 403	200m/s², 100~2000~100Hz, 4cycles, 4min, each X, Y, Z	48minutes	#1	0/10
Electrostatic Discharges	JEITA ED-4701 300 304	HBM, 2kV, $1.5k\Omega$ , $100pF$ , $3pulses$ , alternately positive or negative		#1	0/22

#### NOTES:

- 1) Test board: FR4 board thickness=1.6mm, copper layer thickness=0.07mm, R<sub>θJA</sub>≈20°C/W
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

### (2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
	Forward Voltage(V <sub>F</sub> )	I <sub>F</sub> =1400mA	>Initial value×1.1
#1	Luminous Flux(Φ <sub>V</sub> )	I <sub>F</sub> =1400mA	<initial td="" value×0.7<=""></initial>
#2	Solderability	-	Less than 95% solder coverage

#### **CAUTIONS**

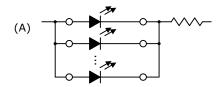
(1) Storage

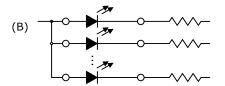
	Conditions	Temperature	Humidity	Time
_	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
Storage	After Opening Aluminum Bag	≤30°C	≤70%RH	≤168hours
Baking		65±5°C	-	≥24hours

- Product complies with JEDEC MSL 3 or equivalent. See IPC/JEDEC STD-020 for moisture-sensitivity details.
- Absorbed moisture in LED packages can vaporize and expand during soldering, which can cause interface delamination
  and result in optical performance degradation. Products are packed in moisture-proof aluminum bags
  to minimize moisture absorption during transportation and storage.
  - Included silica gel desiccants change from blue to red if moisture had penetrated bags.
- After opening the moisture-proof aluminum bag, the products should go through the soldering process within the range of the conditions stated above. Unused remaining LEDs should be stored with silica gel desiccants in a hermetically sealed container, preferably the original moisture-proof bags for storage.
- After the "Period After Opening" storage time has been exceeded or silica gel desiccants are no longer blue, the products should be baked. Baking should only be done once.
- Although the leads or electrode pads (anode and cathode) of the product are plated with gold,
  prolonged exposure to a corrosive environment might cause the gold plated the leads or electrode pads to tarnish,
  and thus leading to difficulties in soldering. If unused LEDs remain, they must be stored in a hermetically sealed container.
   Nichia recommends using the original moisture-proof bag for storage.
- Do not use sulfur-containing materials in commercial products. Some materials, such as seals and adhesives, may contain sulfur. The contaminated plating of LEDs might cause an open circuit. Silicone rubber is recommended as a material for seals. Bear in mind, the use of silicones may lead to silicone contamination of electrical contacts inside the products, caused by low molecular weight volatile siloxane.
- To prevent water condensation, please avoid large temperature and humidity fluctuations for the storage conditions.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment where the temperature is higher than normal room temperature.

### (2) Directions for Use

When designing a circuit, the current through each LED must not exceed the Absolute Maximum Rating.
 Operating at a constant current per LED is recommended. In case of operating at a constant voltage, Circuit B is recommended.
 If the LEDs are operated with constant voltage using Circuit A, the current through the LEDs may vary due to the variation in Forward Voltage characteristics of the LEDs.





- This product should be operated using forward current. Ensure that the product is not subjected to either forward or reverse voltage while it is not in use. In particular, subjecting it to continuous reverse voltage may cause migration, which may cause damage to the LED die. When used in displays that are not used for a long time, the main power supply should be switched off for safety.
- It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.
- Ensure that excessive voltages such as lightning surges are not applied to the LEDs.
- For outdoor use, necessary measures should be taken to prevent water, moisture and salt air damage.

### (3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the bump to break, which will cause the LED not to illuminate.
- When handling the product with tweezers, be careful not to apply excessive force to the resin.
   Otherwise, The resin can be cut, chipped, delaminate or deformed, causing bump-bond breaks and catastrophic failures.
- Dropping the product may cause damage.
- Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause bump to break, leading to catastrophic failures.

#### (4) Design Consideration

- PCB warpage after mounting the products onto a PCB can cause the package to break.
   The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.
- The position and orientation of the LEDs affect how much mechanical stress is exerted on the LEDs placed near the score lines.

  The LED should be placed in a way to minimize the stress on the LEDs due to board flexing.
- Board separation must be performed using special jigs, not using hands.
- If an aluminum PCB is used, customer is advised to verify the PCB with the products before use.

  Thermal stress during use can cause the solder joints to crack.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, packing, adhesive, secondary lens, lens cover, etc.) may penetrate LED lens and/or internal pre-coating resin.
   If the LEDs are being used in a hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output and/or cause a color shift.
   In this case, ventilating the environment may improve the reduction in light output and/or color shift.
   Perform a light-up test of the chosen application for optical evaluation to ensure that there are no issues, especially if the LEDs are planned to be used in a hermetically sealed environment.

### (5) Electrostatic Discharge (ESD)

• The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.

When handling the products, the following measures against electrostatic discharge are strongly recommended:

Eliminating the charge

Grounded wrist strap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

- Ensure that tools (e.g. soldering irons), jigs and machines that are being used are properly grounded and that proper grounding techniques are used in work areas. For devices/equipment that mount the LEDs, protection against surge voltages should also be used.
- If tools or equipment contain insulating materials such as glass or plastic,

the following measures against electrostatic discharge are strongly recommended:

Dissipating static charge with conductive materials

Preventing charge generation with moisture

Neutralizing the charge with ionizers

• The customer is advised to check if the LEDs are damaged by ESD

when performing the characteristics inspection of the LEDs in the application.

Damage can be detected with a forward voltage measurement or a light-up test at low current (≤1mA).

• ESD damaged LEDs may have current flow at a low voltage or no longer illuminate at a low current.

Failure Criteria:  $V_F < 2.0V$  at  $I_F = 0.5mA$ 

#### (6) Thermal Management

- Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design products in a way that the LED die temperature does not exceed the maximum Junction Temperature (T<sub>J</sub>).
- Drive current should be determined for the surrounding ambient temperature (T<sub>A</sub>) to dissipate the heat from the product.
- The following equations can be used to calculate the junction temperature of the products.

1)  $T_J = T_A + R_{\theta JA} \cdot W$  2)  $T_J = T_S + R_{\theta JS} \cdot W$ 

\*T<sub>J</sub>=LED junction temperature: °C

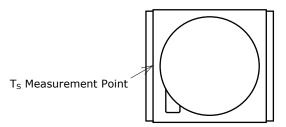
T<sub>A</sub>=Ambient temperature: °C

T<sub>S</sub>=Soldering temperature (cathode side): °C

R<sub>0JA</sub>=Thermal resistance from junction to ambient: °C/W

 $R_{\theta JS}$ =Thermal resistance from junction to  $T_S$  measurement point:  ${}^{\circ}C/W$ 

W=Input power( $I_F \times V_F$ ): W



#### (7) Cleaning

- The LEDs should not be cleaned with water, benzine, and/or thinner.
- If required, isopropyl alcohol (IPA) should be used. Other solvents may cause premature failure to the LEDs due to the damage to the resin portion. The effects of such solvents should be verified prior to use.

  In addition, the use of CFCs such as Freon is heavily regulated.
- When dust and/or dirt adheres to the LEDs, soak a cloth with Isopropyl alcohol (IPA), then squeeze it before wiping the LEDs.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs depending on the ultrasonic power and how LED is assembled.

If ultrasonic cleaning must be used, the customer is advised to make sure the LEDs will not be damaged prior to cleaning.

#### (8) Eye Safety

• In 2006, the International Electrical Commission (IEC) published IEC 62471:2006 Photobiological safety of lamps and lamp systems, which added LEDs in its scope.

On the other hand, the IEC 60825-1:2007 laser safety standard removed LEDs from its scope.

However, please be advised that some countries and regions have adopted standards

based on the IEC laser safety standard IEC 60825-1:20112001, which still includes LEDs in its scope.

Most of Nichia's LEDs can be classified as belonging into either the Exempt Group or Risk Group 1.

High-power LEDs, that emit light containing blue wavelengths, may be classified as Risk Group 2.

Please proceed with caution when viewing directly any LEDs driven at high current, or viewing LEDs with optical instruments which may greatly increase the damages to your eyes.

• Viewing a flashing light may cause eye discomfort. When incorporating the LED into your product, please be careful to avoid adverse effects on the human body caused by light stimulation.

#### (9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria
  as detailed in the Reliability section within this specification; it is the customer's responsibility
  to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required
  for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health.

  This LED does not comply with ISO/TS 16949 and is not intended for automotive applications.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).